



## UT20N03V

Power MOSFET

### 20A, 30V N-CHANNEL ENHANCEMENT MODE POWER MOSFET TRANSISTOR

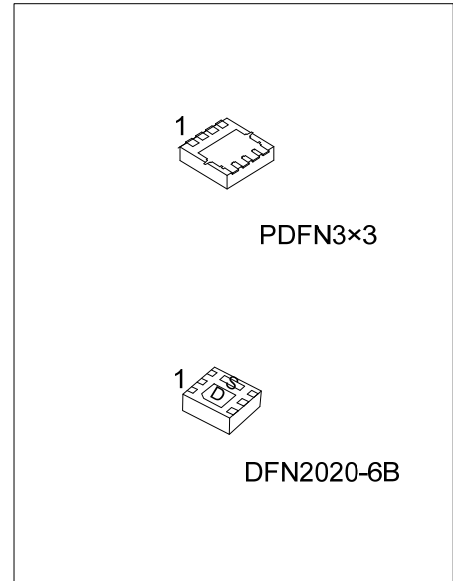
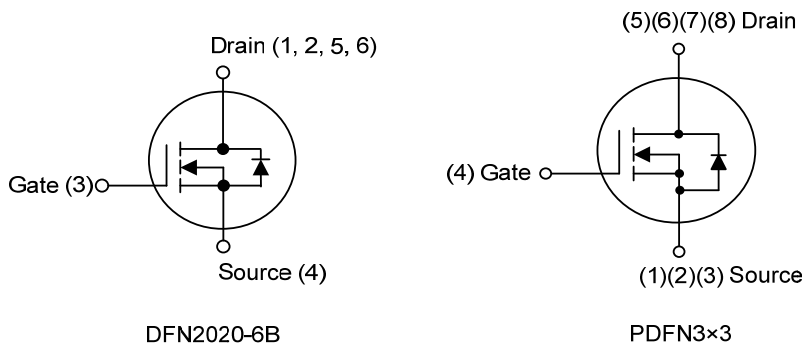
#### DESCRIPTION

The UTC **UT20N03V** is an N-channel enhancement power MOSFET using UTC's advanced technology in the various components of gate charge and capacitance have been optimized to reduce switching losses. Low gate resistance and very low Miller charge enable excellent performance with both adaptive and fixed dead time gate drive circuits. Very low  $R_{DS(ON)}$  has been maintained to provide a sub logic-level device, designed to minimize losses in power conversion applications.

#### FEATURES

- \*  $R_{DS(ON)} \leq 11.5 \text{ m}\Omega @ V_{GS}=10V, I_D=20A$
- $R_{DS(ON)} \leq 16.5 \text{ m}\Omega @ V_{GS}=4.5V, I_D=10A$
- $R_{DS(ON)} \leq 25.5 \text{ m}\Omega @ V_{GS}=2.5V, I_D=7.0A$
- \* High Switching Speed
- \* High Current Capacity

#### SYMBOL



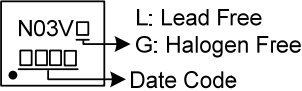
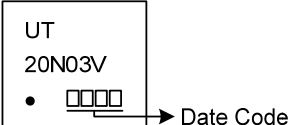
#### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment						Packing		
Lead Free	Halogen Free		1	2	3	4	5	6		7	8
UT20N03VL-P3030-R	UT20N03VG-P3030-R	PDFN3x3	S	S	S	G	D	D	D	D	Tape Reel
UT20N03VL-K06B-2020-R	UT20N03VG-K06B-2020-R	DFN2020-6B	D	D	G	S	D	D	-	-	Tape Reel

Note: Pin Assignment: G: Gate S: Source D: Drain

<p>UT20N03VG-P3030-R</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) R: Tape Reel (2) P3030: PDFN3x3, K06B-2020: DFN2020-6B (3) G: Halogen Free and Lead Free, K: Lead Free</p>
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■ MARKING

DFN2020-6B	PDFN3x3
 <p>N03V□ □□□□ • □□□□</p> <p>L: Lead Free G: Halogen Free Date Code</p>	 <p>UT 20N03V • □□□□</p> <p>Date Code</p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_c=25^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	30	V
Gate-Source Voltage		$V_{GSS}$	$\pm 12$	V
Drain Current	Continuous	$I_D$	20	A
	Pulsed	$I_{DM}$	40	A
Avalanche Energy (Note 3)	Single Pulsed	$E_{AS}$	24.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2	V/ns
Power Dissipation	DFN2020-6B	$P_D$	1.7	W
	PDFN3x3		25	W
Junction Temperature		$T_J$	+150	$^{\circ}\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L = 0.1\text{mH}$ ,  $I_{AS} = 9.9\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^{\circ}\text{C}$ .

4.  $I_{SD} \leq 20\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^{\circ}\text{C}$ .

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	DFN2020-6B	$\theta_{JA}$	270	$^{\circ}\text{C}/\text{W}$
	PDFN3x3		75	$^{\circ}\text{C}/\text{W}$
Junction to Case	DFN2020-6B	$\theta_{JC}$	73.5	$^{\circ}\text{C}/\text{W}$
	PDFN3x3		5	$^{\circ}\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

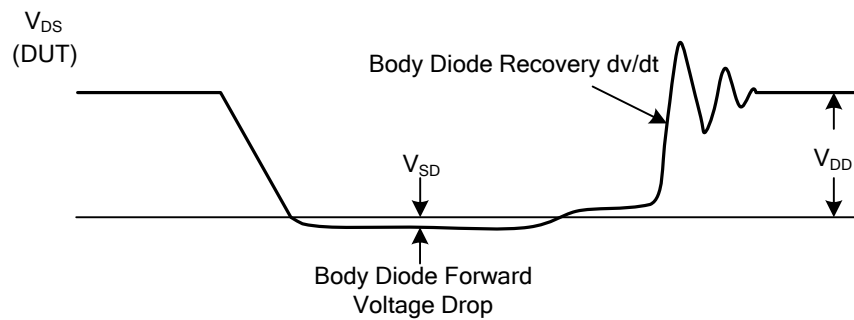
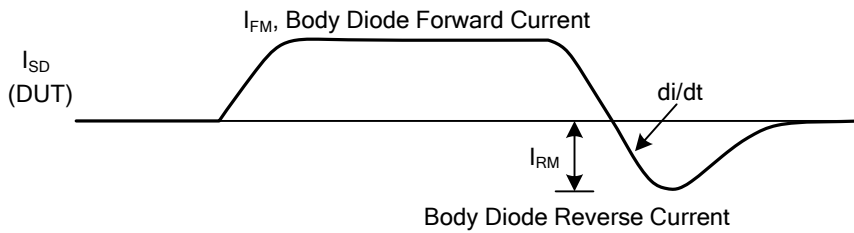
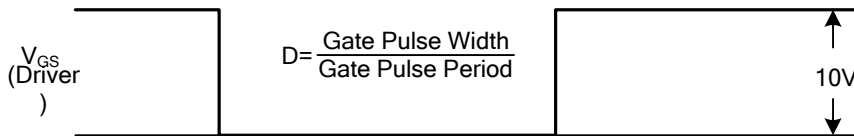
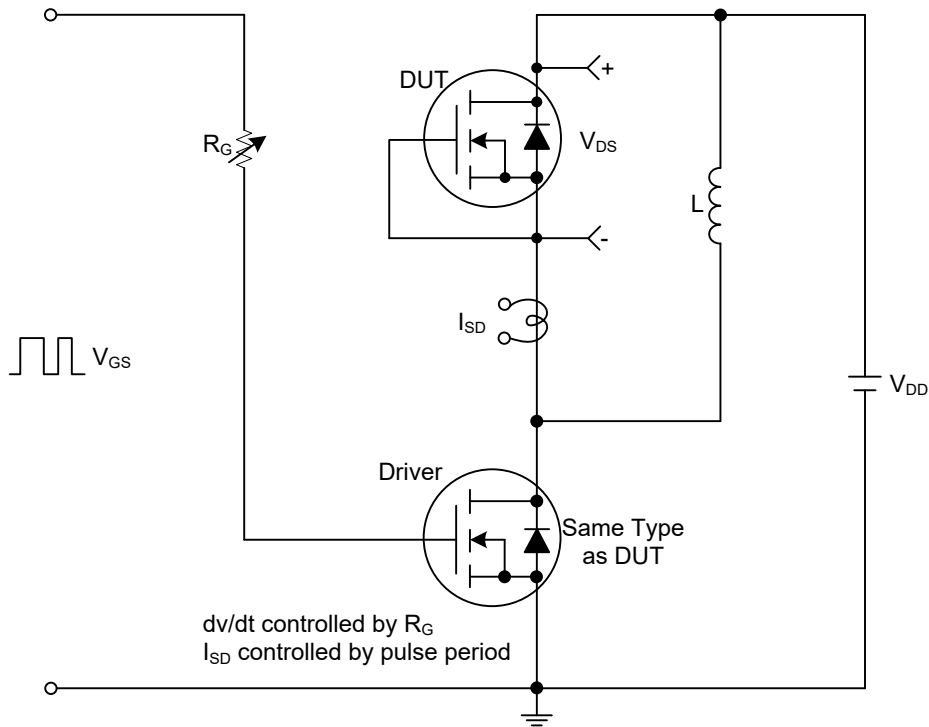
■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	30			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA
Gate- Source Leakage Current	Forward	V <sub>GS</sub> =+12V, V <sub>DS</sub> =0V			+100	nA
	Reverse	V <sub>GS</sub> =-12V, V <sub>DS</sub> =0V			-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5		1.5	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A		9.5	11.5	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A		11.3	16.5	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =7.0A		18	25.5	mΩ
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		972		pF
Output Capacitance	C <sub>OSS</sub>			101		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			88		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> =24V, V <sub>GS</sub> =10V, I <sub>D</sub> =20A (Note1, 2)		38		nC
Gate to Source Charge	Q <sub>GS</sub>			3		nC
Gate to Drain Charge	Q <sub>GD</sub>			8		nC
Turn-ON Delay Time	t <sub>D(ON)</sub>	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =20A, R <sub>G</sub> =3Ω (Note1, 2)		9		ns
Rise Time	t <sub>R</sub>			18		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>			32		ns
Fall-Time	t <sub>F</sub>			20		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	I <sub>S</sub>				20	A
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>				40	A
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time (Note 1)	t <sub>rr</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V,		95		ns
Reverse Recovery Charge	Q <sub>rr</sub>	dI/dt=100A/μs		79		nC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.

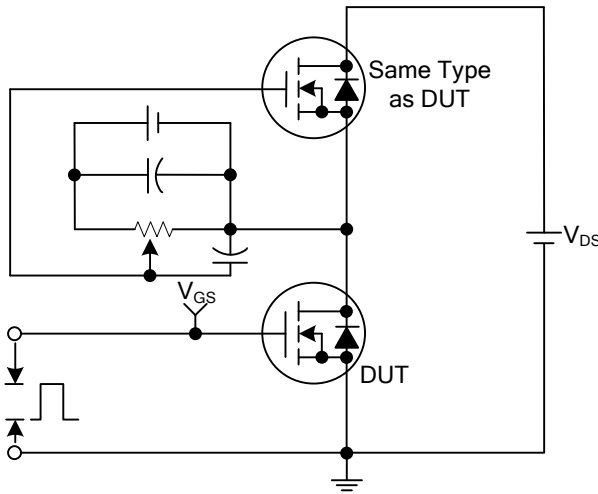
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

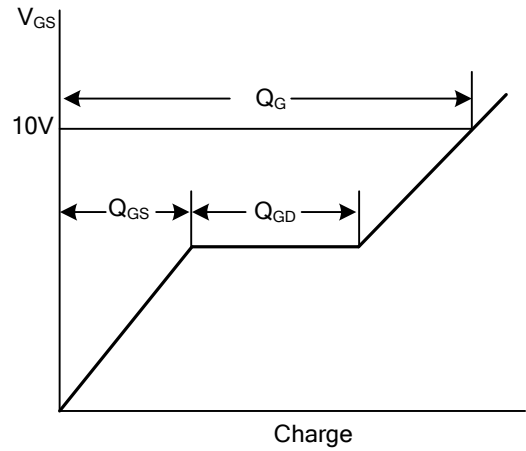


Peak Diode Recovery dv/dt Test Circuit and Waveforms

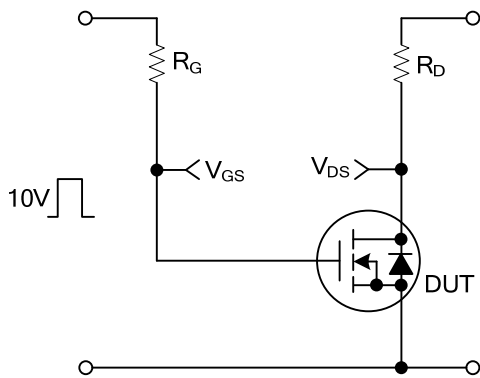
## TEST CIRCUITS AND WAVEFORMS



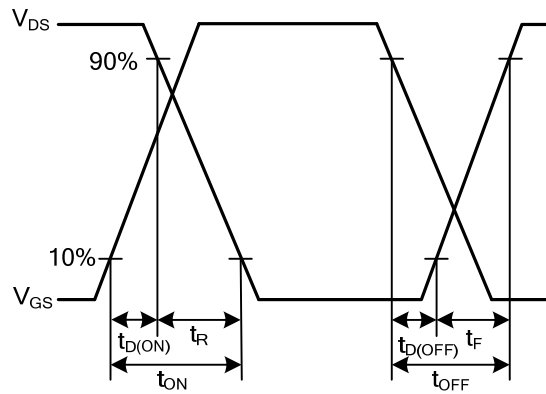
**Gate Charge Test Circuit**



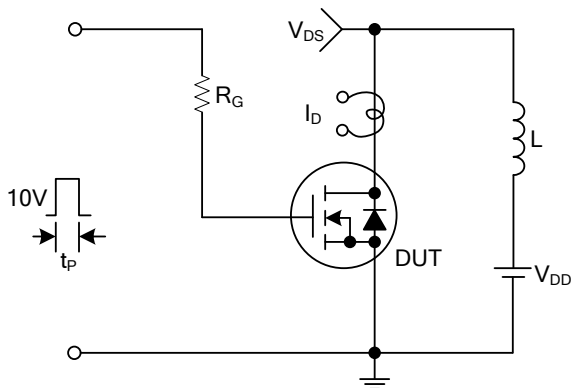
**Gate Charge Waveforms**



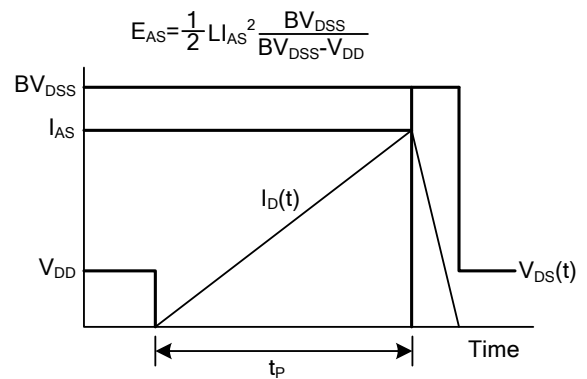
**Resistive Switching Test Circuit**



**Resistive Switching Waveforms**

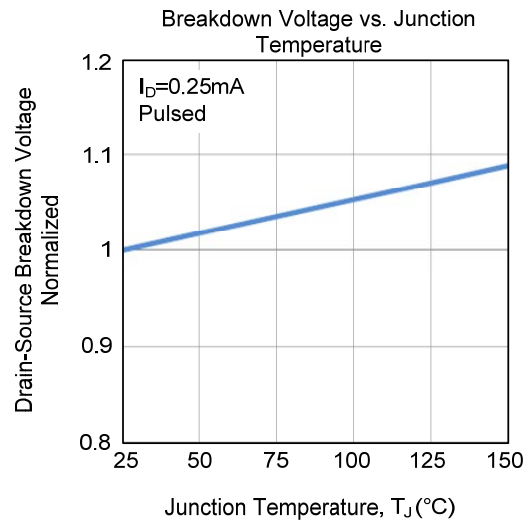
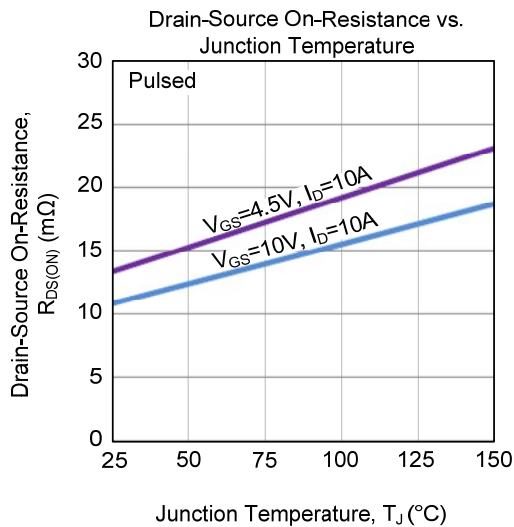
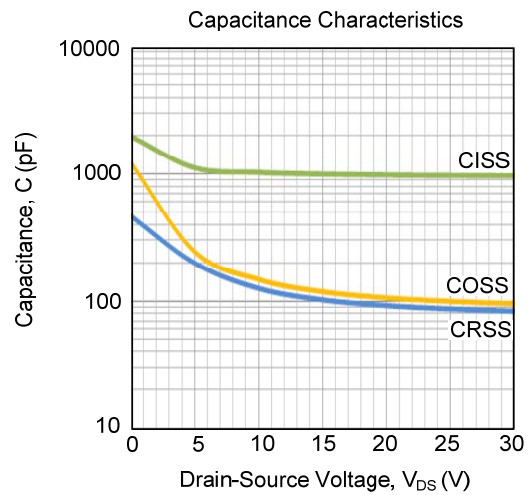
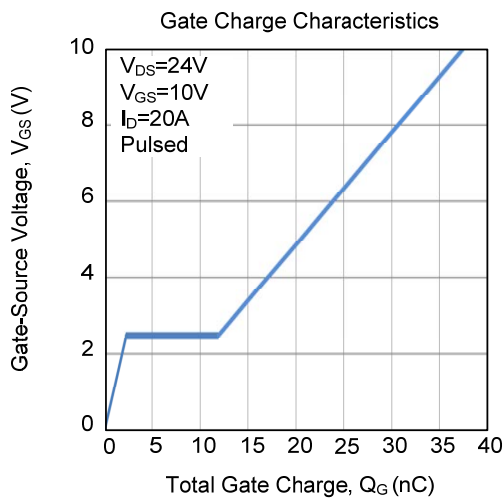
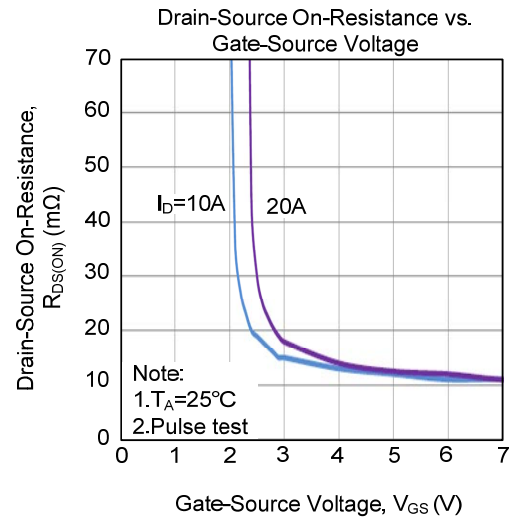
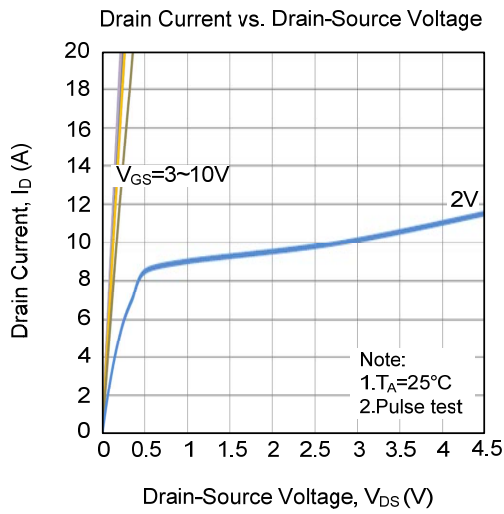


**Unclamped Inductive Switching Test Circuit**

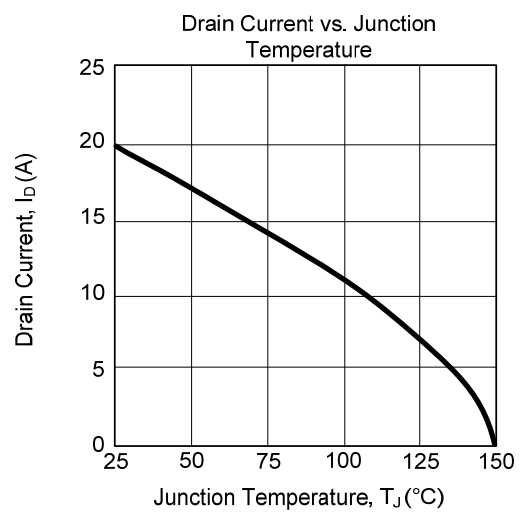
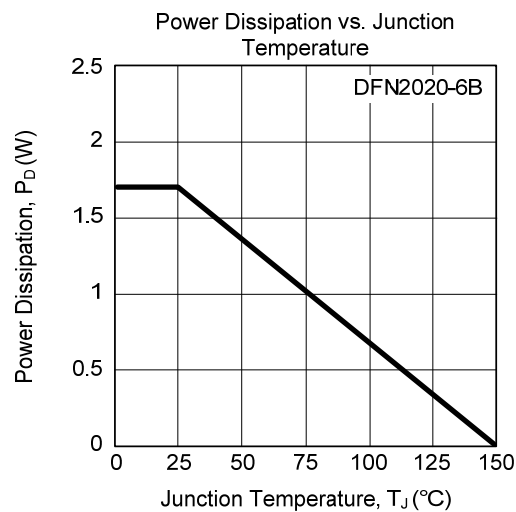
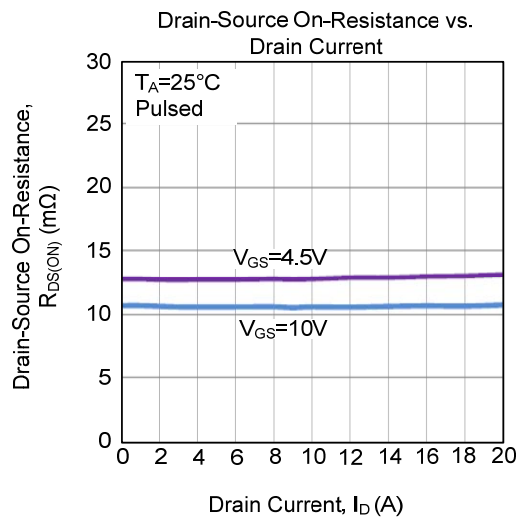
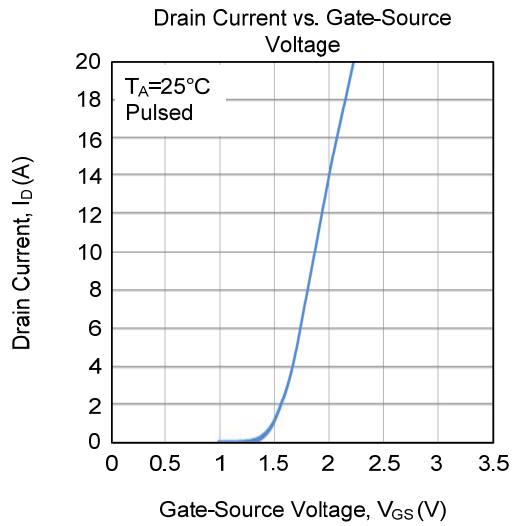
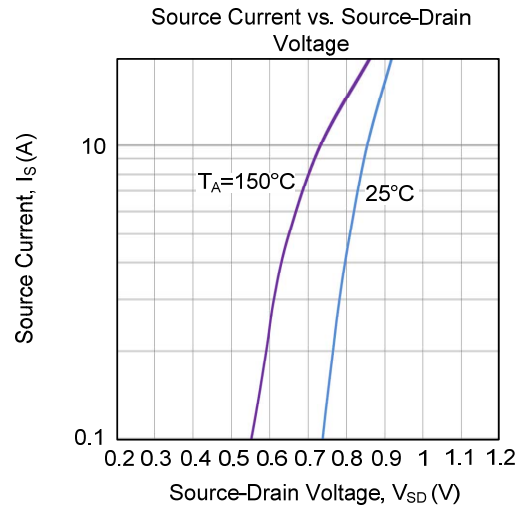
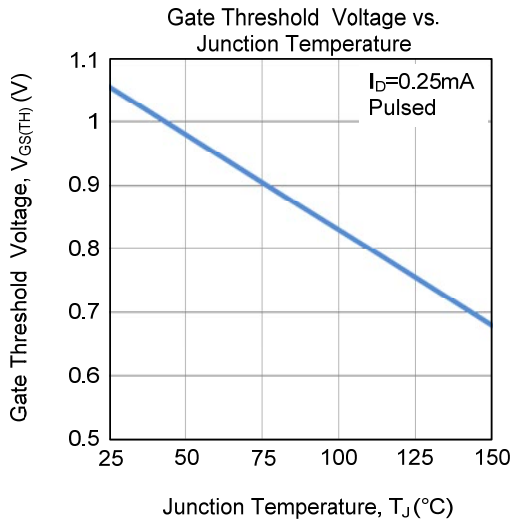


**Unclamped Inductive Switching Waveforms**

## TYPICAL CHARACTERISTICS

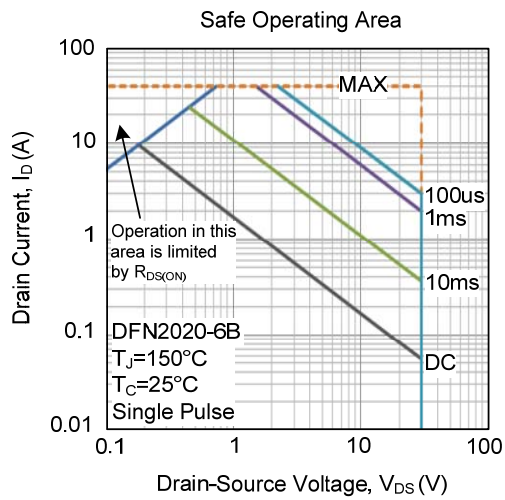


## TYPICAL CHARACTERISTICS (Cont.)





### ■ TYPICAL CHARACTERISTICS (Cont.)



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